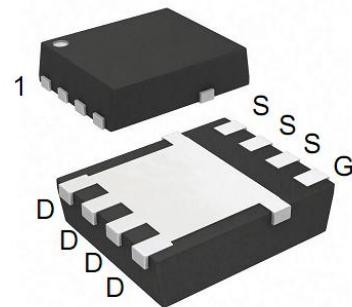


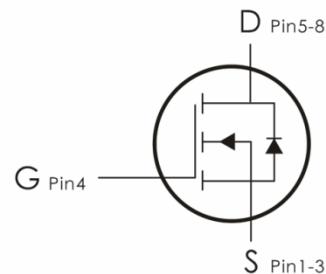
## Description:

This N-Channel MOSFET uses advanced SGT technology and design to provide excellent  $R_{DS(on)}$  with low gate charge. It can be used in a wide variety of applications.



## Features:

- 1)  $V_{DS}=60V, I_D=130A, R_{DS(ON)}<3m\Omega @V_{GS}=10V$
- 2) Low gate charge.
- 3) Green device available.
- 4) Advanced high cell density trench technology for ultra  $R_{DS(ON)}$ .
- 5) Excellent package for good heat dissipation.



## Package Marking and Ordering Information:

Part NO.	Marking	Package	Packing
DON130N06	130N06	DFN5*6-8	5000 pcs/Reel

## Absolute Maximum Ratings: ( $T_c=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Ratings	Units
$V_{DS}$	Drain-Source Voltage	60	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Continuous Drain Current- $TC=25^\circ C$ <sup>1</sup>	130	A
	Continuous Drain Current- $TC=100^\circ C$	95	
	Pulsed Drain Current <sup>2</sup>	390	
$E_{AS}$	Single Pulse Avalanche Energy <sup>5</sup>	80	mJ
$P_D$	Power Dissipation <sup>3</sup>	140	W
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 to +150	°C

## Thermal Characteristics:

Symbol	Parameter	Max	Units
$R_{eJC}$	Thermal Resistance,Junction to Case	0.89	°C/W
$R_{eJA}$	Thermal Resistance Junction to mbient <sup>4</sup>	62	°C/W

**Electrical Characteristics:** ( $T_C=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
<b><math>\text{BV}_{\text{DSS}}</math></b>	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250 \mu\text{A}$	60	---	---	V
<b><math>I_{\text{DSS}}</math></b>	Zero Gate Voltage Drain Current	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=60\text{V}$	---	---	1	$\mu\text{A}$
<b><math>I_{\text{GSS}}</math></b>	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{A}$	---	---	$\pm 100$	nA
<b>On Characteristics</b>						
<b><math>V_{\text{GS}(\text{th})}</math></b>	GATE-Source Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}, I_{\text{D}}=250 \mu\text{A}$	1	1.6	2.5	V
<b><math>R_{\text{DS}(\text{ON})}</math></b>	Drain-Source On Resistance <sup>2</sup>	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=20\text{A}$	---	2.4	3	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=10\text{A}$	---	3.4	4	
<b>Dynamic Characteristics<sup>4</sup></b>						
<b><math>C_{\text{iss}}</math></b>	Input Capacitance	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	---	5377	---	$\text{pF}$
<b><math>C_{\text{oss}}</math></b>	Output Capacitance		---	1666	---	
<b><math>C_{\text{rss}}</math></b>	Reverse Transfer Capacitance		---	77.7	---	
<b>Switching Characteristics<sup>4</sup></b>						
<b><math>t_{\text{d}(\text{on})}</math></b>	Turn-On Delay Time	$V_{\text{DD}}=30\text{V}, I_{\text{D}}=25\text{A}, R_{\text{G}}=2\Omega$	---	22.5	---	ns
<b><math>t_r</math></b>	Rise Time		---	6.7	---	ns
<b><math>t_{\text{d}(\text{off})}</math></b>	Turn-Off Delay Time		---	80.3	---	ns
<b><math>t_f</math></b>	Fall Time		---	26.8	---	ns
<b><math>Q_g</math></b>	Total Gate Charge	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=30\text{V}, I_{\text{D}}=25\text{A}$	---	66.1	---	nC
<b><math>Q_{\text{gs}}</math></b>	Gate-Source Charge		---	10.7	---	nC
<b><math>Q_{\text{gd}}</math></b>	Gate-Drain "Miller" Charge		---	10.9	---	nC
<b>Drain-Source Diode Characteristics</b>						
Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b><math>V_{\text{SD}}</math></b>	Source-Drain Diode Forward Voltage <sup>3</sup>	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=20\text{A}$	---	---	1.3	V
<b><math>I_S</math></b>	Continuous Source Current	$V_D=V_D=0\text{V}$	---	---	130	A
<b><math>I_{\text{SM}}</math></b>	Pulsed Source Current		---	---	390	
<b><math>T_{\text{rr}}</math></b>	Reverse Recovery Time	$I_{\text{S}}=25\text{ A}, \frac{dI}{dt}=100\text{ A}/\mu\text{s}$	---	68.3	---	NS
<b><math>Q_{\text{rr}}</math></b>	Reverse Recovery Charge		---	73	---	NC

**Notes:**

- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3)  $P_d$  is based on max. junction temperature, using junction-case thermal resistance.
- 4) The value of  $R_{\thetaJA}$  is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with  $T_a=25$  °C.
- 5)  $V_{DD}=50$  V,  $R_G=25$  Ω,  $L=0.3$  mH, starting  $T_j=25$  °C.

**Typical Characteristics:** ( $T_c=25$  °C unless otherwise noted)

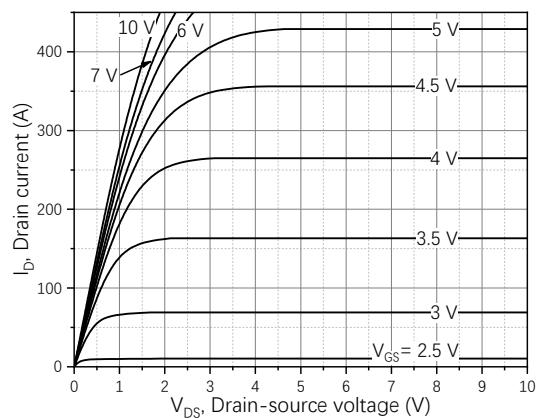


Figure 1, Typ. output characteristics

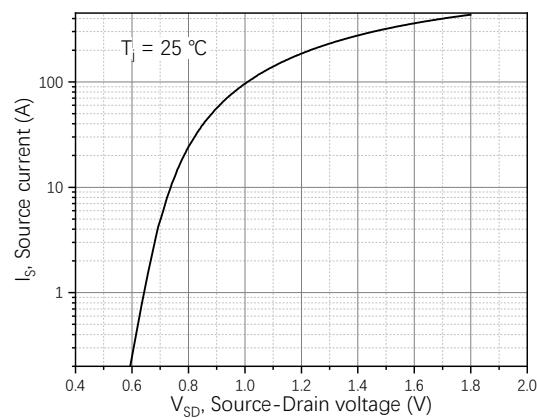


Figure 2, Typ. transfer characteristics

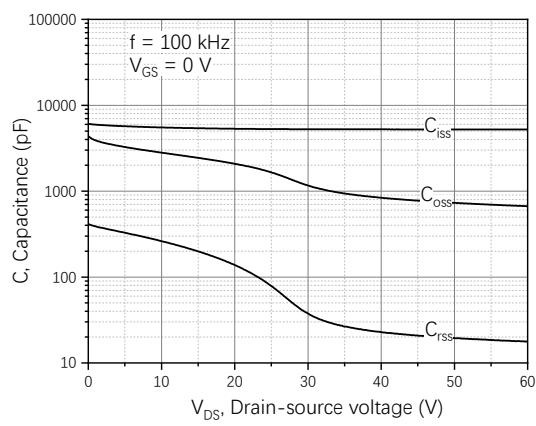


Figure 3, Typ. capacitances

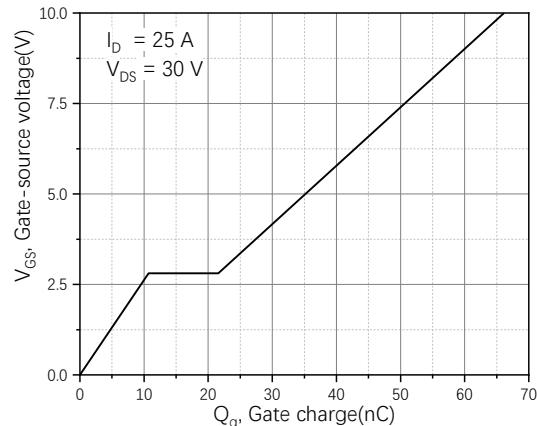


Figure 4, Typ. gate charge

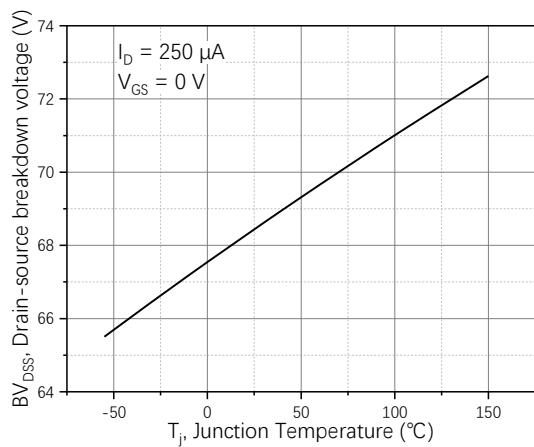


Figure 5, Drain-source breakdown voltage

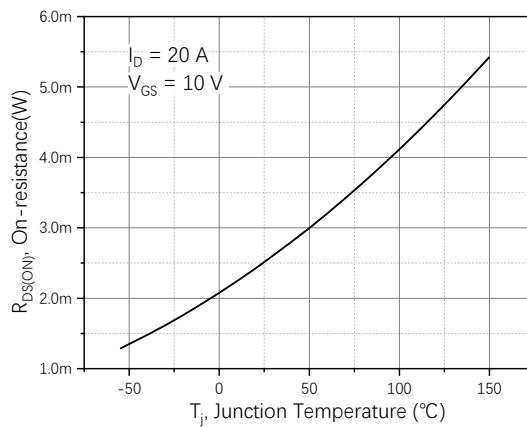


Figure 6, Drain-source on-state resistance

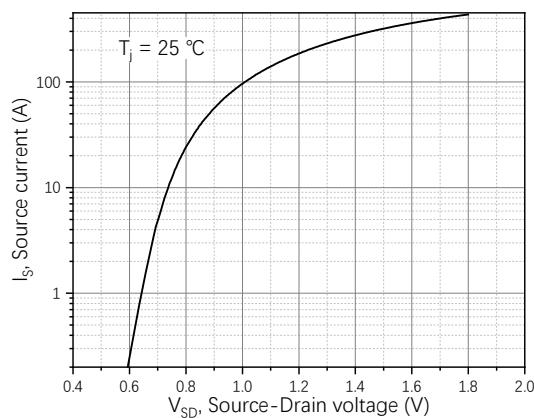


Figure 7, Forward characteristic of body diode

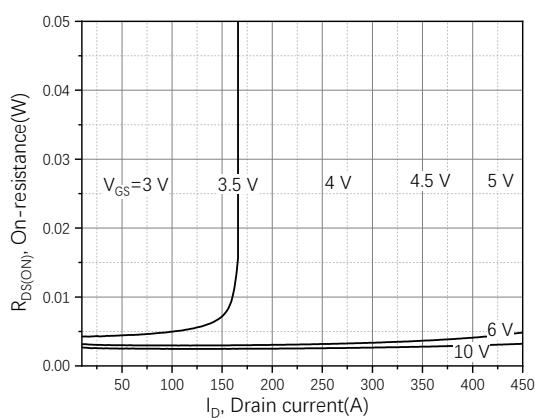
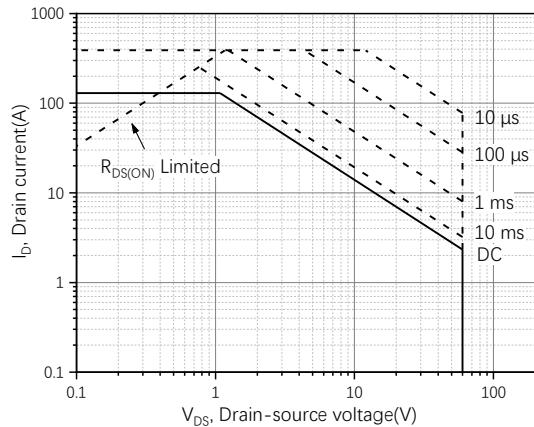
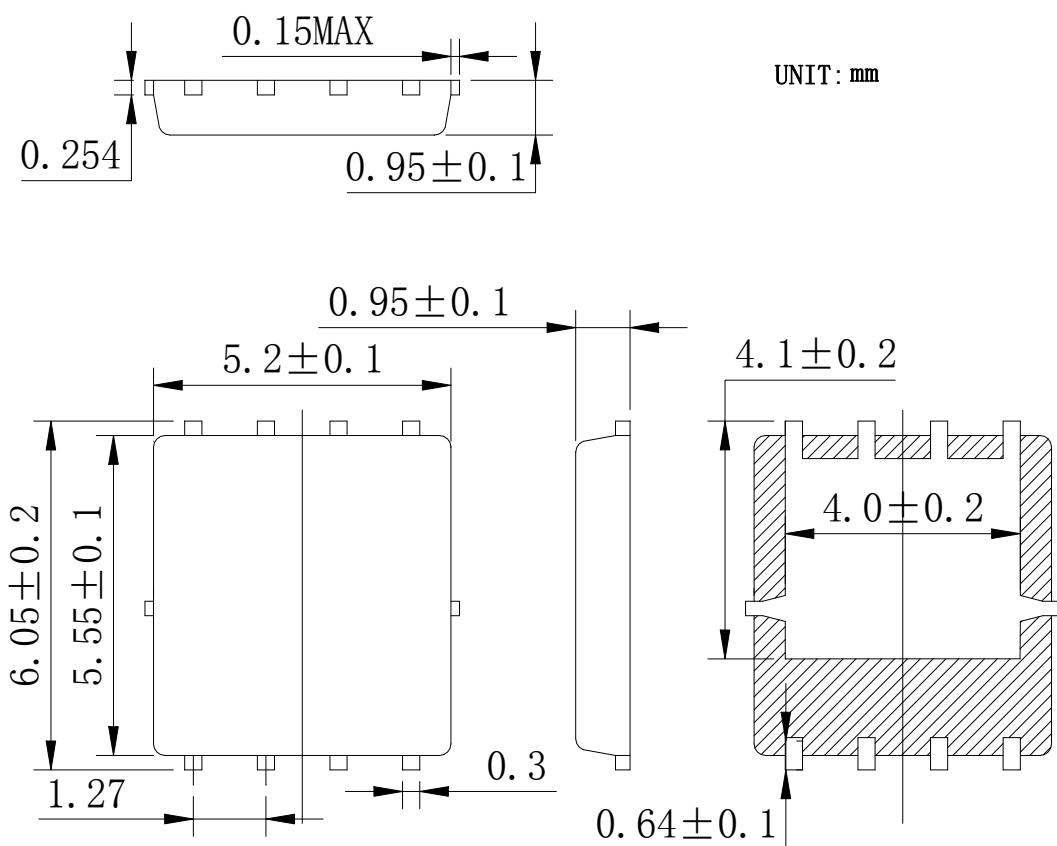


Figure 8, Drain-source on-state resistance

Figure 9, Safe operation area  $T_C=25 ^\circ C$

## DFN5x6-8 Package Information:



## Marking Information:

①. Doingter LOGO

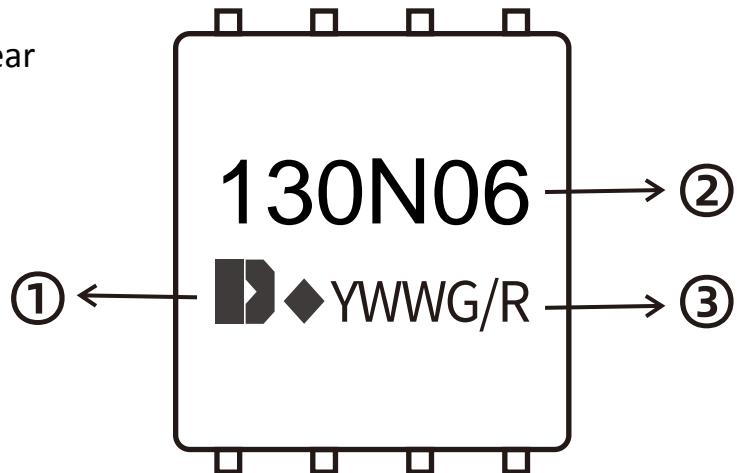
②. Part NO.

③. Date Code(YWWG / R)

Y : Year Code , last digit of the year

WW : Week Code(01-53)

G/R : G(Green) /R(Lead Free)



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